

# Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	75	٧
RMS Reverse Voltage		V <sub>R(RMS)</sub>	53	V
Forward Continuous Current		I <sub>FM</sub>	300	mA
Average Rectified Output Current		lo	200	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	250	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	$T_J$ , $T_{STG}$	-65 to +150	°C

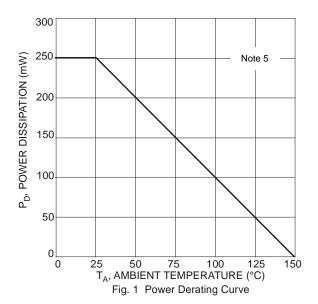
#### Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

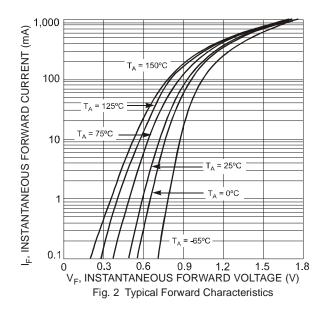
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	75	_	V	$I_R = 100\mu A$
Forward Voltage	V <sub>F</sub>	_	0.715 0.855 1.0 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 6)	I <sub>R</sub>	_	1.0 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$ , $T_J = +150$ °C $V_R = 25V$ , $T_J = +150$ °C $V_R = 20V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

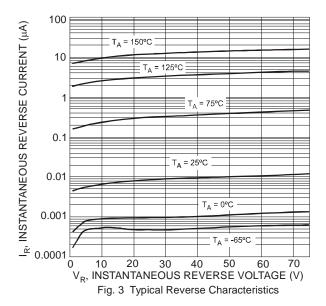
Notes:

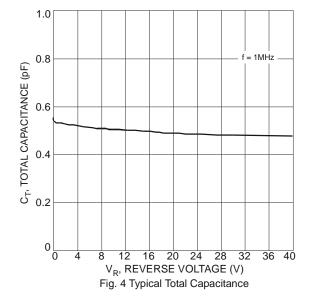
- Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com. Short duration pulse test used to minimize self-heating effect.







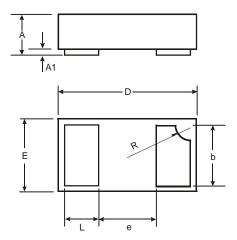






### **Package Outline Dimensions**

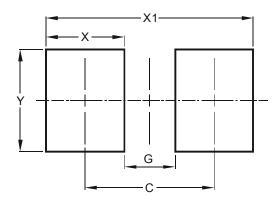
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN1006-2				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	-	-	0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Υ	0.70



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